INTEGRATED CIRCUITS



Preliminary specification File under Integrated Circuits, IC22 May 1993



HILIPS

SAA7186

CONTENTS

- 1 FEATURES
- 2 GENERAL DESCRIPTION
- 3 QUICK REFERENCE DATA
- 4 ORDERING INFORMATION
- 5 BLOCK DIAGRAM
- 6 PINNING
- 7 FUNCTIONAL DESCRIPTION
- 8 OPERATION CYCLE
- 9 I²C-BUS FORMAT
- 10 LIMITING VALUES
- 11 DC CHARACTERISTICS
- 12 AC CHARACTERISTICS
- 13 PROCESSING DELAYS
- 14 PROGRAMMING EXAMPLE
- 15 PACKAGE OUTLINE
- 16 SOLDERING
- 17 DEFINITIONS
- 18 LIFE SUPPORT APPLICATIONS
- 19 PURCHASE OF PHILIPS I²C COMPONENTS



SAA7186

1 FEATURES

- Scaling of video picture windows down to randomly sized windows
- Processes maximum 1023 pixels per line and 1023 lines per field
- Two-dimensional data processing for improved signal quality of scaled video data and for compression of video data
- 16-bit YUV input data buffer
- Interlace/non-interlace video data processing and field control
- Line memories in Y path and UV path to store two lines, each with $2 \times 768 \times 8$ bit capacity
- Vertical sync processing by scale control
- Non-scaled mode to get full picture or to gate videotext lines
- UV input and output data binary/two's complement
- Switchable RGB matrix and anti-gamma ROMs
- 16-word FIFO register for 32-bit output data
- Output formats: 5-bit and 8-bit RGB, 8-bit YUV or 8-bit monochrome

3 QUICK REFERENCE DATA

SYMBOL	PARAMETER	MIN.	MIN. TYP. MAX.				
V _{DD}	supply voltage	4.5	5	5.5	V		
I _{DD tot}	total supply current (inputs LOW, without output load)	-	-	180	mA		
VI	data input level	TT					
Vo	data output level	TT	TTL-compatible				
LLC	input clock frequency	-	-	32	MHz		
T _{amb}	operating ambient temperature range	0	-	70	°C		

4 ORDERING INFORMATION

EXTENDED TYPE		PACKAGE					
NUMBER	PINS	PIN POSITION	MATERIAL	CODE			
SAA7186	100	QFP	plastic	SOT317-2			

2 GENERAL DESCRIPTION

The CMOS circuit SAA7186 scales and filters digital video data to randomly sized picture windows. YUV input data in 4:2:2 format are required (SAA7191B source).

SAA7186

Digital video scaler

5 BLOCK DIAGRAM



SAA7186

6 PINNING

SYMBOL	PIN	STATUS	DESCRIPTION
LNQ	1	0	line qualifier signal; active polarity defined by QPL-bit in "10" (VCLK strobed)
HREFD	2	0	delay-compensated HREF output signal (VCLK strobed)
V _{SS1}	3	_	GND1 (0 V)
i.c.	4	-	internally connected
V _{DD1}	5	-	+5 V supply voltage 1
i.c.	6	-	internally connected
SP	7	I	connected to ground (shift pin for testing)
AP	8	I	connected to ground (action pin for testing)
n.c.	9	-	not connected
UVIN0	10	1	
UVIN1	11	1	
UVIN2	12	1	time-multiplexed colour-difference input data (bits 0 to 3)
UVIN3	13	1	
V _{DD2}	14	_	+5 V supply voltage 2
n.c.	15	_	not connected
V _{SS2}	16	_	GND2 (0 V)
UVIN4	17	1	
UVIN5	18	1	
UVIN6	19	1	time-multiplexed colour-difference input data (bits 4 to 7)
UVIN7	20	1	
n.c.	21	_	not connected
YIN0	22	1	
YIN1	23	1	
YIN2	24	1	luminance input data (bits 0 to 3)
YIN3	25	1	
V _{DD3}	26	_	+5 V supply voltage 3
n.c.	27	_	not connected
V _{SS3}	28	_	GND3 (0 V)
n.c.	29	_	not connected
YIN4	30	1	
YIN5	31	1	
YIN6	32	1	luminance input data (bits 4 to 7)
YIN7	33	1	
n.c.	34	_	not connected
CREF	35	1	clock reference, external sync signal
LLC	36	1	line-locked system clock input signal (twice of pixel rate)
HREF	37	1	horizontal reference, pixel data clock signal (also present during vertical blanking)
VS	38	1	vertical sync input signal (approximately 6 lines long)
n.c.	39	_	not connected
	1		

SYMBOL	PIN	STATUS	DESCRIPTION
n.c.	41	_	not connected
V _{SS4}	42	_	GND4 (0 V)
RESN	43	I	reset input (active-LOW for at least 30LLC periods)
SDA	44	I/O	IIC-bus data line
SCL	45	I	IIC-bus clock line
IICSA	46	I	set module address input of IIC-bus (LOW = B8, HIGH = BC)
BTST	47	1	output disable input; HIGH sets all data outputs to high-impedance state
INCADR	48	0	line increment / vertical reset control output line
HFL	49	0	FIFO register half-full flag output
VOEN	50	1	VRAM port output enable input (active-LOW)
VCLK	51	I	FIFO register clock input signal
n.c.	52	-	not connected
V _{SS5}	53	_	GND5 (0 V)
n.c.	54	-	not connected
V _{DD5}	55	-	+5 V supply voltage 5
VRO31	56	0	
VRO30	57	0	video outruit: 22 hit \/DAM outruit port (hito 24 to 20)
VRO29	58	0	video output; 32-bit VRAM output port (bits 31 to 28)
VRO28	59	0	
n.c.	60	-	not connected
VRO27	61	0	
VRO26	62	0	video output; 32-bit VRAM output port (bits 27 to 24)
VRO25	63	0	
VRO24	64	0	
V _{SS6}	65	-	GND6 (0 V)
n.c.	66	-	not connected
V_{DD6}	67	-	+5 V supply voltage 6
VRO23	68	0	video output; 32-bit VRAM output port (bits 23 to 22)
VRO22	69	0	
VRO21	70	0	video output; 32-bit VRAM output port (bits 21 to 20)
VRO20	71	0	
n.c.	72	-	not connected
VRO19	73	0	
VRO18	74	0	video output; 32-bit VRAM output port (bits 19 to 17)
VRO17	75	0	
V _{DD7}	76	-	+5 V supply voltage 7
VRO16	77	0	video output; 32-bit VRAM output port (bit16)
V _{SS7}	78	_	GND7 (0 V)
n.c.	79	-	not connected

SYMBOL	PIN	STATUS	DESCRIPTION
VRO15	80	0	
VRO14	81	0	video output: 22 hit \/DAM output port /hito 45 to 42)
VRO13	82	0	video output; 32-bit VRAM output port (bits 15 to 12)
VRO12	83	0	
n.c.	84	_	not connected
VRO11	85	0	
VRO10	86	0	video output: 22 hit \/DAM output port /hito 11 to 9)
VRO9	87	0	video output; 32-bit VRAM output port (bits 11 to 8)
VRO8	88	0	
V _{SS8}	89	0	GND8 (0 V)
n.c.	90	-	not connected
V _{DD8}	91	_	+5 V supply voltage 8
VR07	92	0	
VRO6	93	0	video output: 22 hit \/DAM output port /hito 7 to 4)
VRO5	94	0	video output; 32-bit VRAM output port (bits 7 to 4)
VRO4	95	0	
n.c.	96	_	not connected
VRO3	97	0	
VRO2	98	0	video output: 22 hit \/PAM output port /hits 2 to 0\
VRO1	99	0	video output; 32-bit VRAM output port (bits 3 to 0)
VRO0	100	0	

SAA7186

6.1 Pin configuration



SAA7186

7 FUNCTIONAL DESCRIPTION

The input port is output of Philips digital video multistandard decoders (SAA7151B, SAA7191B) or other similar sources.

The SAA7186 input supports the 16-bit YUV 4:2:2 format. The video data from the input port are converted into a unique internal two's complement data stream and are processed in horizontal direction in two separate decimation filters. Then they are processed in vertical direction by the vertical processing unit (VPU). Chrominance data are interpolated to a 4:4:4 format; a chroma keying bit is generated.

The 4:4:4 YUV data are then converted from the YUV to the RGB domain in a digital matrix. ROM tables in the RGB data path can be used for anti-gamma correction of gamma-corrected input signals.

Uncorrected RGB and YUV signals can be bypassed. A scale control unit generates reference and gate signals for scaling of the processed video data. After data formatting to the various VRAM port formats, the scaled video data are buffered in the 16 word × 32-bit output FIFO register. The FIFO output is directly connected to the VRAM output bus VRO(31-0). Specific reference signals support an easy memory interfacing.

All functions of the SAA7186 are controlled via l²C-bus using 17 subaddresses. The external microcontroller can get information by reading the status register.

7.1 Video input port

The 16-bit YUV input data in 4:2:2 format (Table 1) consist of 8-bit luminance data Y (pins YIN(7-0)) and 8-bit time-multiplexed colour-difference data UV (pins UVIN(7-0)).

The input data are clocked in by the signals LLC and CREF (Fig.3). HREF and VS inputs define the video scan pattern (window).

Sequential input data

- are limited to maximum 768 active pixels per line if the vertical filter is active
- UV can be processed in straight binary and two's complement representation (controlled by TCC)

7.2 Decimation filters

The decimation filters perform accurate horizontal filtering of the input data stream.

Signal characteristics are matched in front of the pixel decimation stage, thus disturbing artifacts, caused by the pixel dropping, are reduced. The signal bandwidth can be reduced in steps of:

2-tap filter = -6 dB at 0.325 pixel rate

3-tap filter = -6 dB at 0.25 pixel rate

4-tap filter = -6 dB at 0.21 pixel rate

5-tap filter = -6 dB at 0.125 pixel rate

9-tap filter = -6 dB at 0.075 pixel rate

The different characteristics are chosen dependent on the defined scaling parameters in an adaptive filter mode (AFS-bit = 1).

The filter characteristics can also be selected independently by control bits HF2 to HF0 at AFS-bit = 0.

7.3 Vertical filters

Y and UV data are handled in separate filters (Fig.1). Each of the two line memories has a capacity of $2 \times 768 \times 8$ -bit. Thus two complete video lines of 4:2:2 YUV data can be stored. The VPU is split into two memory banks and one arithmetic unit. The available processing modes, respectively transfer functions, are selectable by the bits VP1 and VP0 if AFS = 0.

An adaptive mode is selected by AFS = 1. Disturbing artifacts, generated by line dropping, are reduced.

Adaptive filter selection (AFS = 1):

SCALING RATIO	FILTER FUNCTION (REFER TO I ² C SECTION)
XD/XS	horizontal
≤1	bypassed
≤14/15	filter 1
≤11/15	filter 6
≤7/15	filter 3
≤3/15	filter 4
YD/YS	vertical
≤1	bypassed
≤13/15	filter 1
≤4/15	filter 2

SAA7186

7.4 RGB matrix

Y data and UV data are converted after interpolation into RGB data according to CCIR601 recommendation. Data are bypassed in YUV or monochrome modes.

Table 14 : 2 : 2 format (pixels per line). The time frames
are controlled by the HREF signal.

INPUT	I	PIXEL B	YTE SE	QUENC	E
YIN7	Ye7	Yo7	Ye7	Yo7	Ye7
YIN6	Ye6	Yo6	Ye6	Yo6	Ye6
YIN5	Ye5	Yo5	Ye5	Yo5	Ye5
YIN4	Ye4	Yo4	Ye4	Yo4	Ye4
YIN3	Ye3	Yo3	Ye3	Yo3	Ye3
YIN2	Ye2	Yo2	Ye2	Yo2	Ye2
YIN1	Ye1	Yo1	Ye1	Yo1	Ye1
YIN0	Ye0	Yo0	Ye0	Yo0	Ye0
UVIN7	Ue7	Ve7	Ue7	Ve7	Ue7
UVIN6	Ue6	Ve6	Ue6	Ve6	Ue6
UVIN5	Ue5	Ve5	Ue5	Ve5	Ue5
UVIN4	Ue4	Ve4	Ue4	Ve4	Ue4
UVIN3	Ue3	Ve3	Ue3	Ve3	Ue3
UVIN2	Ue2	Ve2	Ue2	Ve2	Ue2
UVIN1	Ue1	Ve1	Ue1	Ve1	Ue1
UVIN0	Ue0	Ve0	Ue0	Ve0	Ue0
Y frame	0	1	2	3	4
UV frame	0		2		4

Note

1. e = even pixel; o = odd pixel

The matrix equations are these considering the digital quantization:

R = Y + 1.375 V G = Y - 0.703125 V - 0.34375 UB = Y + 1.734375 U.

Anti-gamma ROM tables:

ROM tables are implemented at the matrix output to provide anti-gamma correction of the RGB data. A curve for a gamma of 1.4 is implemented

The tables can be used (RTB-bit = 0) to compensate gamma correction for linear data representation of RGB output data.

7.5 Chrominance signal keyer

The keyer generates an alpha signal to achieve a 5-5-5 + α RGB alpha output signal. Therefore, the processed UV data amplitudes are compared with thresholds set via I²C-bus (subaddresses "0C to 0F"). A logical "1" signal is generated if the amplitude is inside the specified amplitude range, otherwise a logical "0" is generated. Keying can be switched off by setting the lower limit higher than the upper limit ("0C or 0E" and "0D or 0F").

7.6 Scale control and vertical regions

The scale control block SC includes vertical address/sequence counters to define the current position in the input field and to address the internal VPU memories.

To perform scaling, XD of XS pixel selection in horizontal direction and YD of YS line selection in vertical direction are applied. The pixel and line dropping are controlled at the input of the FIFO register. To control the decimation filter function and the vertical data processing in the adaptive mode (AFS = 1), the scaling ratio in horizontal and vertical direction is estimated in the SC block.

The input field can be divided into two vertical regions – the bypass region and the scaling region, which are defined via I^2 C-bus by the parameters VS, VC, YO and YS.

Vertical bypass region:

Data are not scaled and independent of I²C-bits FS1, FS0 the output format is always 8-bit greyscale (monochrome). The SAA7186 outputs all active pixels of a line, defined by the HREF input signal if the vertical bypass region is active. This can be used, for example, to store videotext information in the field memory.

The start line of the bypass region is defined by VS; the number of lines to be bypassed is defined by VC.

Vertical scaling region:

Data is scaled with start at line YO and the output format is selected when FS1, FS0 are valid. This is the "normal operation" area.

The input/output screen dimensions in horizontal and

vertical direction are defined by the parameters

XO, XS and XD for horizontal

YO, YS and YD for vertical.

The circuit processes XS samples of a line. Remaining pixels are ignored if a line is longer than XS. If a line is

SAA7186

shorter than XS, processing is aborted when the falling edge of HREF is detected.

Vertical regions in Fig.4:

- the two regions can be programmed via I²C-bus, whereby regions should not overlap (active region overrides the bypass region).
- the start of a normal active picture depends on video standard and has to be programmed to the correct value.
- the offsets XO and YO have to be set according to the internal processing delays to ensure the complete number of destination pixels and lines (Table 6).
- the scaling parameters can be used to perform a panning function over the video frame/field.



SAA7186

7.7 Output data representation and levels

Output data representation of the YUV data can be modified by bit MCT (subaddress 10). The DC gain is 1 for YUV input data. The corresponding RGB levels are defined by the matrix equations. The luminance levels are limited according to CCIR 601

16 (239) = black

235 (20) = white

(..) = greyscale luminance levels

if the YUV or monochrome luminance output formats are selected.

The signal levels of the RGB formats are limited in 8-bit to "0" or "255". For the 5-bit RGB formats a truncation from 8-bit to 5-bit is implemented.

Fill values are inserted dependent on longword position and destination size:

- "0" in RGB formats and for Y two's complement U, V
- "128" for U, V (straight binary)
- "255" in 8-bit greyscale format

The unused output values of the YUV and greyscale formats can be used for other purposes.



SAA7186

PIXEL OUTPUT BITS	R	61 = 0; F RGB 5-5- 2-BIT WC	5 + 1		61 = 0; F\$ YUV 4:2 2-BIT WC	2:2	YI	61 = 1; F JV 4:2:2 6-BIT WC	TEST	8-BIT	1 = 1; F\$ MONOC -BIT WO	HROME
PIXEL ORDER	n	n+2	n+4	n	n+2	n+4	n	n+1	n+2	n n+1	n+4 n+5	n+8 n+9
VRO31	α	α	α	Ye7	Ye7	Ye7	Ye7	Yo7	Ye7	Ya7	Ya7	Ya7
VRO30	R4	R4	R4	Ye6	Ye6	Ye6	Ye6	Yo6	Ye6	Ya6	Ya6	Ya6
VRO29	R3	R3	R3	Ye5	Ye5	Ye5	Ye5	Yo5	Ye5	Ya5	Ya5	Ya5
VRO28	R2	R2	R2	Ye4	Ye4	Ye4	Ye4	Yo4	Ye4	Ya4	Ya4	Ya4
VRO27	R1	R1	R1	Ye3	Ye3	Ye3	Ye3	Yo3	Ye3	Ya3	Ya3	Ya3
VRO26	R0	R0	R0	Ye2	Ye2	Ye2	Ye2	Yo2	Ye2	Ya2	Ya2	Ya2
VRO25	G4	G4	G4	Ye1	Ye1	Ye1	Ye1	Yo1	Ye1	Ya1	Ya1	Ya1
VRO24	G3	G3	G3	Ye0	Ye0	Ye0	Ye0	Yo0	Ye0	Ya0	Ya0	Ya0
VRO23	G2	G2	G2	Ue7	Ue7	Ue7	Ue7	Ve7	Ue7	Yb7	Yb7	Yb7
VRO22	G1	G1	G1	Ue6	Ue6	Ue6	Ue6	Ve6	Ue6	Yb6	Yb6	Yb6
VRO21	G0	G0	G0	Ue5	Ue5	Ue5	Ue5	Ve5	Ue5	Yb5	Yb5	Yb5
VRO20	B4	B4	B4	Ue4	Ue4	Ue4	Ue4	Ve4	Ue4	Yb4	Yb4	Yb4
VRO19	B3	B3	B3	Ue3	Ue3	Ue3	Ue3	Ve3	Ue3	Yb3	Yb3	Yb3
VRO18	B2	B2	B2	Ue2	Ue2	Ue2	Ue2	Ve2	Ue2	Yb2	Yb2	Yb2
VRO17	B1	B1	B1	Ue1	Ue1	Ue1	Ue1	Ve1	Ue1	Yb1	Yb1	Yb1
VRO16	B0	B0	B0	Ue0	Ue0	Ue0	Ue0	Ve0	Ue0	Yb0	Yb0	Yb0
PIXEL ORDER	n+1	n+3	n+5	n+1	n+3	n+5	OUTP	OUTPUTS NOT USED		n+2 n+3	n+6 n+7	n+10 n+11
VRO15 VRO14 VRO13 VRO12	α R4 R3 R2	α R4 R3 R2	α R4 R3 R2	Yo7 Yo6 Yo5 Yo4	Yo7 Yo6 Yo5 Yo4	Yo7 Yo6 Yo5 Yo4	X X X X X	X X X X	X X X X	Yc7 Yc6 Yc5 Yc4	Yc7 Yc6 Yc5 Yc4	Yc7 Yc6 Yc5 Yc4
VRO11	R1	R1	R1	Yo3	Yo3	Yo3	X	X	X	Yc3	Yc3	Yc3
VRO10	R0	R0	R0	Yo2	Yo2	Yo2	X	X	X	Yc2	Yc2	Yc2
VRO9	G4	G4	G4	Yo1	Yo1	Yo1	X	X	X	Yc1	Yc1	Yc1
VRO8	G3	G3	G3	Yo0	Yo0	Yo0	X	X	X	Yc0	Yc0	Yc0
VRO7	G2	G2	G2	Ve7	Ve7	Ve7	X	X	X	Yd7	Yd7	Yd7
VRO6	G1	G1	G1	Ve6	Ve6	Ve6	X	X	X	Yd6	Yd6	Yd6
VRO5	G0	G0	G0	Ve5	Ve5	Ve5	X	X	X	Yd5	Yd5	Yd5
VRO4	B4	B4	B4	Ve4	Ve4	Ve4	X	X	X	Yd4	Yd4	Yd4
VRO3	B3	B3	B3	Ve3	Ve3	Ve3	X	X	X	Yd3	Yd3	Yd3
VRO2	B2	B2	B2	Ve2	Ve2	Ve2	X	X	X	Yd2	Yd2	Yd2
VRO1	B1	B1	B1	Ve1	Ve1	Ve1	X	X	X	Yd1	Yd1	Yd1
VRO0	B0	B0	B0	Ve0	Ve0	Ve0	X	X	X	Yd0	Yd0	Yd0

Table 2VRAM port output data formats at **EFE-bit = 0** dependent on FS1 and FS0 bits (set via I^2 C-bus)

Note

 α = keying bit; R, G, B, Y, U and V = digital signals; e = even pixel number; o = odd pixel number; a b c d = consecutive pixels

SAA7186

PIXEL OUTPUT BITS	R	1 = 0; F\$ GB 5-5-\$ -BIT WC	5 + 1		61 = 0; FS YUV 4:2 6-BIT WO	:2		1 = 1; FS RGB 8-8 -BIT WO	-8	8-BIT	I = 1; FS MONOC ·BIT WO	HROME
PIXEL ORDER	n	n+1	n+2	n	n+1	n+2	n	n+1	n+2	n n+1	n+2 n+3	n+4 n+5
VRO31	α	α	α	Ye7	Yo7	Ye7	R7	R7	R7	Ya7	Ya7	Ya7
VRO30	R4	R4	R4	Ye6	Yo6	Ye6	R6	R6	R6	Ya6	Ya6	Ya6
VRO29	R3	R3	R3	Ye5	Yo5	Ye5	R5	R5	R5	Ya5	Ya5	Ya5
VRO28	R2	R2	R2	Ye4	Yo4	Ye4	R4	R4	R4	Ya4	Ya4	Ya4
VRO27	R1	R1	R1	Ye3	Yo3	Ye3	R3	R3	R3	Ya3	Ya3	Ya3
VRO26	R0	R0	R0	Ye2	Yo2	Ye2	R2	R2	R2	Ya2	Ya2	Ya2
VRO25	G4	G4	G4	Ye1	Yo1	Ye1	R1	R1	R1	Ya1	Ya1	Ya1
VRO24	G3	G3	G3	Ye0	Yo0	Ye0	R0	R0	R0	Ya0	Ya0	Ya0
VRO23	G2	G2	G2	Ue7	Ve7	Ue7	G7	G7	G7	Yb7	Yb7	Yb7
VRO22	G1	G1	G1	Ue6	Ve6	Ue6	G6	G6	G6	Yb6	Yb6	Yb6
VRO21	G0	G0	G0	Ue5	Ve5	Ue5	G5	G5	G5	Yb5	Yb5	Yb5
VRO20	B4	B4	B4	Ue4	Ve4	Ue4	G4	G4	G4	Yb4	Yb4	Yb4
VRO19	B3	B3	B3	Ue3	Ve3	Ue3	G3	G3	G3	Yb3	Yb3	Yb3
VRO18	B2	B2	B2	Ue2	Ve2	Ue2	G2	G2	G2	Yb2	Yb2	Yb2
VRO17	B1	B1	B1	Ue1	Ve1	Ue1	G1	G1	G1	Yb1	Yb1	Yb1
VRO16	B0	B0	B0	Ue0	Ve0	Ue0	G0	G0	G0	Yb0	Yb0	Yb0
PIXEL ORDER	n	n+1	n+2	n	n+1	n+2	n	n+1	n+2	n n+1	n+2 n+3	n+4 n+5
VRO15	X	X	X	X	X	X	B7	B7	B7	X	X	X
VRO14	X	X	X	X	X	X	B6	B6	B6	X	X	X
VRO13	X	X	X	X	X	X	B5	B5	B5	X	X	X
VRO12	X	X	X	X	X	X	B4	B4	B4	X	X	X
VRO11	X	X	X	X	X	X	B3	B3	B3	X	X	X
VRO10	X	X	X	X	X	X	B2	B2	B2	X	X	X
VRO9	X	X	X	X	X	X	B1	B1	B1	X	X	X
VRO8	X	X	X	X	X	X	B0	B0	B0	X	X	X
VRO7 (2, 3)	α	α	α	α	X	α	α	α	α	α	α	α
VRO6 (3)	O/E	O/E	O/E	O/E	O/E	O/E	O/E	O/E	O/E	O/E	O/E	O/E
VRO5 (3)	VGT	VGT	VGT	VGT	VGT	VGT	VGT	VGT	VGT	VGT	VGT	VGT
VRO4 (3)	HGT	HGT	HGT	HGT	HGT	HGT	HGT	HGT	HGT	HGT	HGT	HGT
VRO3	X	X	X	X	X	X	X	X	X	X	X	X
VRO2 (3)	HRF	HRF	HRF	HRF	HRF	HRF	HRF	HRF	HRF	HRF	HRF	HRF
VRO1 (3)	LNQ	LNQ	LNQ	LNQ	LNQ	LNQ	LNQ	LNQ	LNQ	LNQ	LNQ	LNQ
VRO0 (3)	PXQ	PXQ	PXQ	PXQ	PXQ	PXQ	PXQ	PXQ	PXQ	PXQ	PXQ	PXQ

 Table 3
 VRAM port output data formats at EFE-bit = 1 dependent on FS1 and FS0 bits (set via l²C-bus)

Notes

 α = keying bit; R, G, B, Y, U and V = digital signals; e = even pixel number; o = odd pixel number; a b c d = consecutive pixels; O/E = odd/even flag

2. YUV 16-bit format: the keying signal α is defined only for YU time steps. The corresponding YV sample has also to be keyed. The α signal in monochrome mode can be used only in the transparent mode (TTR = 1), in this case Ya = Yb.

3. Data valid only when transparent mode active (TTR-bit = 1) and VCLK pin connected to LLC/2 clock rate.

7.8 Output FIFO register and VRAM output port

The output FIFO register is the buffer between the video data stream and the VRAM data input port. Resized video data are buffered and formatted. 32-, 24- and 16-bit video data modes are supported. The various formats are selected by the bits EFE, FS1 and FS0. VRAM port formats are shown in Tables 2 and 3. The FIFO register capacity is 16 word \times 32 bit (for 32-, 24-, or 16-bit video data). The bits LW1 and LW0 can be used to define the position of the first pixel each line in the 32-bit longword formats or to shift the UV sequence to VU in the 16-bit YUV formats (LW1 = 1).

VRAM port inputs are:

VCLK to clock the FIFO register output data and VOEN to enable output data.

VRAM port outputs are:

the HFL flag (half-full flag), the signal INCADR (refer to section "data burst transfer") and the reference signals for pixel and line selection on outputs VRO(7-0) (only for 24-and 16-bit video data formats refer to "transparent data transfer").

7.9 VRAM port transfer procedures

Data transfer on the VRAM port can be done asynchronously controlled by outputs HFL, INCADR and input VCLK (data burst transfer with bit TTR = 0).

Data transfer on the VRAM port can be done synchronously controlled by output reference signals on outputs VRO(7-0) and a clock rate of LLC/2 on input VCLK (transparent data transfer with bit TTR = 1 and EFE = 1). The scaling capability of the SAA7186 can be used in various applications.

7.10 Data burst transfer mode

Data transfer on the VRAM port is asynchronously (TTR = 0). This mode can be used for all output formats. Four signals for communication with the external memory are provided.

• HFL flag, the half-full flag of the FIFO output register is raised when the FIFO contains at least 8 data words (HFL = HIGH). By setting HFL = 1, the SAA7186 requests a data burst transfer by the external memory controller, that has to start a transfer cycle within the next 32 LLC cycles for 32-bit longword modes (16 LLC cycles for 16- and 24-bit modes). If there are pixels in the FIFO at the end of a line, which are not transferred, the circuit fills up the FIFO register with "fill pixels" until it is half-full and sets the HFL flag to request a data burst transfer. After transfer is done, HFL is used in

combination with INCADR to indicate the line increments (Figures 6 and 7).

- INCADR output signal is used in combination with HFL to control horizontal and vertical address generation for a memory controller. The pulse sequence depends on field formats (interlace/ non-interlace or odd/even fields, Figures 6 and 7) and control bits OF (subaddress 00).
 - HFL = 1 at the rising edge of INCADR:

the end of line is reached, request for line address increment

HFL = 0 at the rising edge of INCADR:

the end of field/frame is reached, request for line and pixel addresses reset

(The distance from the last half-full request HFL to the INCADR pulse may be longer than $64 \times LLC$. The HFL state is defined for minimum $4 \times LLC$ in front of the rising edge of INCADR and minimum $2 \times LLC$ afterwards.)

- VCLK input signal to clock the FIFO register output data VRO(n). New data are placed on the VRO(n) port with the rising edge of VCLK (Fig.5).
- VOEN input enables output data VRO(n). The outputs are in 3-state mode at VOEN = HIGH. VOEN changes only when VCLK is LOW. If VCLK pulses are applied during VOEN = HIGH, the outputs remain inactive, but the FIFO register accepts the pulses.

7.11 Transparent data transfer mode

Data transfer on the VRAM port can be achieved synchronously (TTR = 1). With a continuous clock rate of LLC/2 on input VCLK, the SAA7186 delivers a continuously processed data stream. Therefore, the extended formats of the VRAM output port have to be selected (bit EFE = 1; Table 3). The reference and gate signals on outputs VRO(6-1) and the LNQ signal are delivered in each field (means scaled and ignored fields). The PXO signal (also VRO0) is only delivered in active fields. The output signals VRO(7-0) can be used to buffer qualified pre-processed RGB or YUV video data (notice: the YUV data are only valid in qualified time slots). Control output signals in Table 3 are:

SAA7186

- α keying signal of the chroma keyer
- O/E odd/even field bit according to the internal field processing
- VGT vertical gate signal, "1" marks the scaling window in vertical direction from YO to (YO + YS) lines, cut by VS.
- HGT horizontal gate signal, "1" marks horizontal direction from XO to (XO + XS) lines, cut by HREF.
- HRF delay compensated horizontal reference signal.
- LNQ line qualifier signal, active polarity is defined by QPL bit.
- PXQ pixel qualifier signal, active polarity is defined by QPP bit.

7.12 Power-on reset

- the FIFO register contents are undefined
- outputs VRO are set to high-impedance state
- output INCADR = HIGH
- output HFL = LOW until the VPE bit is set to "1"
- subaddress "10" is set to 00h and VPE-bit in subaddress "00" is set to zero (Table 4).









7.13 Field processing

The phase of the field sequence (odd/even dependent on inputs HREF and VS) is detected by means of the falling edge of VS. The current field phase is reported in the status byte by the OEF bit (Table 5). OEF bit can be stable 0 or 1 for non-interlaced input frames or non standard input signals VS and/or HREF (nominal condition for VS and HREF – SAA7191 B with active vertical noise limiter). A free-running odd/even flag is generated for internal field processing if the detection reports a stable OEF bit.

The POE bit (subaddress 0B) can be used to change the polarity of the internal flag (in case of non-standard VS and HREF signals) to control the phase of the free-running flag, and to compensate mis-detections. Thus, the SAA7186 can be used under various VS/HREF timing conditions.

The SAA7186 operates on fields. To support progressive displays and to avoid movement blurring and artifacts, the circuit can process both or single fields of interlaced or non-interlaced input data. Therefore the OF bits can be used. The bits OF1 and OF0 (Table 6) determine the INCADR/HFL generation in "data burst transfer mode". One of the fields (odd or even) is ignored when OF1 = 1; then no line increment sequence (INCADR/HFL) is generated, the vertical reset pulse is only generated.

With OF1 = OF0 = 0 the circuit supports correct interlaced data storage. Two INCADR/HFL sequences are generated in each qualified line; additionally an INCADR/HFL sequence after the vertical reset sequence of an odd field is generated. Thereby, the scaled lines are automatically stored in the right sequence.

8 OPERATION CYCLE

The operation is synchronized by the input field. The cycle is specified in the flow chart (Fig.9).

The circuit is inactive after power-on reset, VPO is 0 and the FIFO control is set "empty". The internal control registers are updated with the falling edge of VS signal. The circuit is switched active and waits for a transmission of VS and a vertical reset sequence to the memory controller. Afterwards, the circuit waits for the beginning of a scaling or bypass region. The processing of a current line is finished when a vertical sync pulse appears. The circuit performs a coefficient update and generates a new vertical reset (if it is still active).

Line processing starts when a line is decided to be active, the circuit starts to scale it. Active pixels are loaded into the FIFO register. An HFL flag is generated to initialize a data transfer when eight words are completed. The line end is reached when the programmed pixel number is processed or when a horizontal sync pulse occurs. If there are pixels in the FIFO register, it is filled up until it is half-full to cause a data transfer. Horizontal increment pulses are transmitted after this data transfer.

Remarks:

The SAA7186 will always wait for the HREF/VS pulse before the line increment/vertical reset sequence is performed. After each line/field, the FIFO control is set to empty when INCADR/HFL sequence is transmitted. No additional actions are necessary if the memory controller has ignored the HFL signal. There is no need to handle overflow/underflow of the FIFO register.









SAA7186

9 I²C-BUS FORMAT

S SEAVE ADDRESS A SUBADDRESS A DATAU A DATAU A P	S	SLAVE ADDRESS	А	SUBADDRESS		DATA0	А		DATAn	А	Р
--	---	---------------	---	------------	--	-------	---	--	-------	---	---

S	=	start condition
SLAVE ADDRESS	=	1011 100X (IICSA = LOW) or 1011 110X (IICSA = HIGH)
А	=	acknowledge, generated by the slave
SUBADDRESS ⁽¹⁾	=	subaddress byte (Table 4)
DATA	=	data byte (Table 4)
Р	=	stop condition
Х	=	read/write control bit
		X = 0, order to write (the circuit is slave receiver)
		X = 1, order to read (the circuit is slave transmitter)

Note

1. If more than 1 byte DATA are transmitted, then auto-increment of the subaddress is performed.

SAA7186

FUNCTION						DAT	Α				
FUNCTION	SUBAD	DRESS	D7	D6	D5	D4	D3	D2	D1	D0	DF ⁽¹⁾
Formats and s	sequence	00	RTB	OF1	OF0	VPE	LW1	LW0	FS1	FS0	tbf
Output data pi	ixel/line	01	XD7	XD6	XD5	XD4	XD3	XD2	XD1	XD0	
continu	ied in	04							XD9	XD8	
Input data pixe	el/line	02	XS7	XS6	XS5	XS4	XS3	XS2	XS1	XS0	
continu	ied in	04					XS9	XS8			
Horizontal win	dow start	03	XO7	XO6	XO5	XO4	XO3	XO2	XO1	XO0	
Pixel decimati	on filter	04	HF2	HF1	HF0	XO8	XS9	XS8	XD9	XD8	
Output data lir	nes/field	05	YD7	YD6	YD5	YD4	YD3	YD2	YD1	YD0	
continu	ied in	09							YD9	YD8	
Input data lines/field		06	YS7	YS6	YS5	YS4	YS3	YS2	YS1	YS0	
continu	continued in						YS9	YS8			
Vertical window start		07	Y07	YO6	YO5	YO4	YO3	YO2	YO1	YO0	
AFS/vertical p	rocessing	08	AFS	VP1	VP0	YO8	YS9	YS8	YD9	YD8	
Vertical bypas	s start	09	VS7	VS6	VS5	VS4	VS3	VS2	VS1	VS0	
continu	ied in	0B				VS8					
Vertical bypas	s count	0A	VC7	VC6	VC5	VC4	VC3	VC2	VC1	VC0	
continu	ied in	0B	тсс	0	0	VS8	0	VC8	0	POE	
Chroma keyin	g										
lower limit fo	or V	0C	VL7	VL6	VL5	VL4	VL3	VL2	VL1	VL0	
upper limit f		0D	VU7	VU6	VU5	VU4	VU3	VU2	VU1	VU0	
lower limit fo		0E	UL7	UL6	UL5	UL4	UL3	UL2	UL1	UL0	
upper limit f	or U	0F	007	006	005	004		002			
Byte 10 ⁽²⁾		10	0	0	0	MCT	QPL	QPP	TTR	EFE	
Unused		11 to 1F									

Table 4 I^2C -bus; subaddress and data bytes for writing (X in address byte = 0).

Notes

1. Default register contents fill in by hand

2. Byte 10 is set to 00h after power-on reset.

Table 5	I^2C -bus status byte (X in address byte = 1)
---------	---

EUN	FUNCTION					DATA								
FUN					D7	D6	D5	D4	D3	D2	D1	D0		
status b	yte				ID3	ID2	ID1	ID0	0	0	OEF	SVP		
Function	n of statu	s bits:			1									
ID3	to	ID0	Software	e version	of SAA718	86 compa	atible with	า						
			ID3	ID2	ID1	ID0		versio	n					
			0	0	0	1		1		-				
OEF	OEF Identification of field sequence dependent on inputs HREF and VS: 0 = even field detected; 1 = odd field detected													
SVP			State of	State of VRAM port:			•	EL and IN		,				

SAA7186

"00" RTB			ROM table bypass switch:0 = anti-gamma ROM active1 = table is bypassed					ctive			
OF1	to	OF0	Set outp	ut field	mode:						
			OF1	С	F0	field mo	de DVS	process			
			0	0		1		terlaced s	torage		
			0	1					ed storage	е	
			1	0					•		non-interlaced storage
			1	1							non-interlaced storage
VPE			VRAM p	ort outp	outs ena	ро 1	osition (HFL = LC and INCA	W, INCAE	DR =	VRO outputs in 3-state = HIGH) VRO outputs dependent
LW1	to	LW0	First pixe	el positi	on in VF	RO data fo	or FS1 =	= 0; FS0 =	0 (RGB) a	and	FS1 = 0; FS0 = 1 (YUV):
			LW1	LW0	31 to 2	24 23	3 to 16	15 to 8	7 to 0		
			0	0	pixel () pi	ixel 0	pixel 1	pixel 1)	
			0	1	pixel (•	ixel 0	pixel 1	pixel 1	ý	EFE = 0, TRR = 0
			1	0	black	bl	lack	pixel 0	pixel 0)	
			1	1	black	bl	lack	pixel 0	pixel 0)	
			First pixe	el positi	on in VI	RO data fo	or FS1 =	= 1; FS0 =	1 (monoc	hro	me):
			LW1	LW0	31 to 2	24 23	3 to 16	15 to 8	7 to 0		
			0	0	pixel () pi	ixel 1	pixel 2	pixel 3)	
			0	1	black	pi	ixel 0	pixel 1	pixel 2)	EFE = 0, TRR = 0
			1	0	black	bl	lack	pixel 0	pixel 1)	
			1	1	black	bl	lack	black	pixel 0)	
			0	0	pixel (ia (ixel 1	х	х)	EFE = 1, TRR = 0;
			0	1	black	•	ixel 0	X	Х	ý	LW only effects
			1	0	pixel (•	ixel 1	Х	Х)	greyscale format
			1	1	black	pi	ixel 0	Х	Х)	

 Table 6
 Function of the register bits of Table 4

FS1	to	FS0	FIFO out	out reg	ister forn	nat select (EFE-bit see "10"):
			EFE	FS1	FS0	output format (Tables 2 and 3)
			0	0	0	RGB 5-5-5 + alpa; 2×16-bit/pixel; 32-bit word length; RGB matrix on, VRAM output format
			0	0	1	YUV 4:2:2; 2×16-bit/pixel; 32-bit word length; RGB matrix off, VRAM output format
			0	1	0	YUV 4:2:2; video test mode; 1×16-bit/pixel; 16-bit word length; RGB matrix off, optional output format
			0	1	1	monochrome mode; 4×8-bit/pixel; 32-bit word length; RGB matrix off, VRAM output format
			1	0	0	RGB 5-5-5 + alpa; 1×16 -bit/pixel; 16-bit word length; RGB matrix on, VRAM output + transparent format
			1	0	1	YUV 4:2:2 + alpa; 1×16-bit/pixel; 16-bit word length; RGB matrix off, VRAM output + transparent format
			1	1	0	RGB 8-8-8 + alpa; 1×24-bit/pixel; 24-bit word length; RGB matrix on, VRAM output + transparent format
			1	1	1	monochrome mode; 2×8-bit/pixel; 16-bit word length; RGB matrix off, VRAM output + transparent format
"01 and	04"					
XD9	to	XD0		•		raight binary) on output (VRO): 1111 (number of XS pixels as a maximum)
"02 and	04"					
XS9	to	XS0				raight binary) on inputs (YIN and UVIN): 1111 (number of input pixels per line as maximum)
"03 and	04"					
XO8	to	XO0	number p	er line).	(straight binary) of scaling window (take care of active pixel ter HREF rise = 0 0001 0000 to 1 1111 1111 (010 to 1FF)
						v end may be cut by internal delay compensated HREF = 0 tched to the internal processing delay to get full scaling range

"04"							
"04" ⊔⊑2	to		Horizont		motion	iltor (E	auros 12 and 14);
HF2	to	HF0				1	gures 13 and 14):
			HF2	HF1	HF0	taps	filter
			0	0	0	2	filter 1 (1/2 (1 + z^{-1}))
			0	0	1	3	filter 2 (1/4 (1 + $2z^{-1} + z^{-2})$)
			0	1	0	5	filter 3 (1/8 (1 + $2z^{-1}$ + $2z^{-2}$ + $2z^{-3}$ + z^{-4}))
			0	1	1	9	filter 4 (1/16 (1 + $2z^{-1}$ + $2z^{-2}$ + $2z^{-3}$ + $2z^{-4}$ + $2z^{-5}$ + $2z^{-6}$ + $2z^{-7}$ + z^{-8}))
			1	0	0	1	filter bypassed
			1	Õ	1	1	filter bypassed + delay in Y channel of 1T
			1	1	0	8	filter 5 (1/16 (1 + $3z^{-1}$ + $3z^{-2}$ + z^{-3} + z^{-4} + $3z^{-5}$
				·	C C		$+3z^{-6}+z^{-7}))$
			1	1	1	4	$(1/8 (1 + 3z^{-1} + 3z^{-2} + z^{-3}))$
"05 and (08"						
YD9	to	YD0		•	•	•	straight binary):
			00 0000	0000	to 11 111	1 1111	(number of YS lines as a maximum)
"06 and (08"						
YS9	to	YS0	Line nur	nber p	er input f	field (st	raight binary):
			00 0	000 00	00		0 line
			11 1	111 111	1		1023 lines (maximum = number of lines/field -3)
"07 and ()8"						
YO8	to	YO0			-		v. "0" equals 3rd line after rising slope of VS input signal. er per field (straight binary).
			0 000	000 000) start v	with 3rd	d line after the rising slope of VS
							t line after the falling slope of nominal VS (SAA7151B/91B)
			1 111	1 1111	511 +	3 lines	after the rising slope of VS (maximum value)
"08"							
AFS			Adaptive	e filter s	switch:		ff; use VP1, VP0 and HF2 to HF0 bits
						1 = o	n; filter characteristics are selected by the scaler
VP1	to	VP0	Vertical	data pi	ocessin	a a	
				VP0	proce	-	
				0		-	
			0	1	bypas		line $H(z) = z^{-H}$
			1	0			1: $(H(z) = 1/2 (1 + z^{-H}))$
			1	1			$2: (H(z) = 1/2 (1 + 2z^{-H}))$
"09 and ()B"						
VS8	to	VS0	Vertical override			-	in of the bypass region (straight binary). Scaling region bits):
				• •	-		d line after the rising slope of VS
				00 001			at line after the falling slope of nominal VS (SAA7151B/91B)
				11 1111			s after the rising slope of VS (maximum value)
			1				

"0A and	0B"				
VC8	to	VC0	00 0000 0000	, sets length of bypass regio 0 line length 11 lines length (maximum =	
тсс			Two's complement inp	out data select (U, V):	0 = binary input data 1 = two's complement input data
POE			Polarity, internally det	ected odd/even flag O/E:	
			0 = flag	unchanged; 1 = fla	g inverted
"0C"					
VL7	to	VL0	Set lower limit for V co	olour-difference signal (8 bi	;; two's complement):
			1000 0000 0000 0000 0111 1111	as maximum negative va limit = 0 as maximum positive va	-
"0D"				as maximum positive va	
VU7	to	VU0	Set upper limit for V c	olour-difference signal (8 bi	t; two's complement):
			1000 0000 0000 0000	as maximum negative v limit = 0	-
			0111 1111	as maximum positive va	lue = +127 signal level
"0E"					
UL7	to	UL0	Set lower limit for U co	olour-difference signal (8 bi	t; two's complement):
			1000 0000	as maximum negative v	alue = –128 signal level
			0000 0000	limit = 0	
"oF"			0111 1111	as maximum positive va	lue = +127 signal level
"0F"	1.				
UU7	to	UU0		olour-difference signal (8 b	· · ·
			1000 0000	as maximum negative v	alue = -128 signal level
			0000 0000	limit = 0	lue – ±127 signal level
			0111 1111	as maximum positive va	lue = +127 signal level

"10" MCT	 Monochrome and two's complement output data select: 0 = inverse greyscale luminance (if greyscale is selected by FS bits) or straight binary U, V data output 1 = non-inverse monochrome luminance (if greyscale is selected by FS bits) or two's complement U, V data output
QPL	Line qualifier polarity flag : 0 = LNQ is active-LOW (pin 1 and on VRO1, pin 99); 1 = LNQ is active-HIGH
QPP	Pixel qualifier polarity flag : 0 = PXQ is active-LOW (VRO0, pin 100); 1 = PXQ is active-HIGH
TTR	Transparent data transfer: 0 = normal operation (VRAM protocol valid,) 1 = FIFO register transparent (output FIFO in shift register mode)
EFE	Extended formats enable, FS-bits in subaddress "00"

SAA7186

Digital video scaler





HF2 to HF0 bits (subaddress 04).

SAA7186

10 LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	MIN.	MAX.	UNIT
V _{DD}	supply voltage (pins 5, 14, 26, 40, 55, 67, 76 and 91)	-0.5	6.5	V
VI	DC input voltage on all pins	-0.5	V _{DD}	V
I _{DD}	supply current (pins 5, 14, 26, 40, 55, 67, 76 and 91)	_	70	mA
P _{tot}	total power dissipation	0	1	W
T _{stg}	storage temperature range	-65	150	°C
T _{amb}	operating ambient temperature range	0	70	°C
V _{ESD}	electrostatic handling ⁽¹⁾ for all pins	_	±2000	V

Note

1. Equivalent to discharging a 100 pF capacitor through a 1.5 k Ω series resistor.

11 DC CHARACTERISTICS

 V_{DD1} to V_{DD8} = 4.5 to 5.5 V; T_{amb} = 0 to 70 $^{\circ}C$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{DD}	supply voltage range (pins 5, 14, 26, 40, 55, 67, 76 and 91)		4.5	5	5.5	V
I _P	total supply current $(I_{DD1} + I_{DD2} + I_{DD3} + I_{DD4} + I_{DD5} + I_{DD6} + I_{DD7} + I_{DD8})$	inputs LOW and outputs without load	-	80	-	mA
Data and c	ontrol inputs			-		-
VIL	input voltage LOW		-0.5	-	0.8	V
VIH	input voltage HIGH		2.0	_	V _{DD} +0.5	V
ILI	input leakage current	V _{IL} = 0	-	-	10	μA
CI	input capacitance	data	-	_	8	pF
		clocks	-	-	10	pF
Data and c	ontrol outputs		·	-	·	-
V _{OL}	output voltage LOW	note 1	_	_	0.6	V
V _{OH}	output voltage HIGH	note 1	2.4	_	-	V
3-state out	puts	•			•	
I _{O off}	high-impedance output current		_	-	±5	μA
Co	high-impedance output capacitance		-	_	8	pF
I ² C-bus, SI	DA and SCL (pins 44 and 45)	•	•	•		L
VIL	input voltage LOW		-0.5	_	1.5	V
VIH	input voltage HIGH		3	-	V _{DD} +0.5	V
I _{44, 45}	input current		-	-	±10	μA
I _{ACK}	output current on pin 44	acknowledge	3	-	-	mA
V _{OL}	output voltage at acknowledge	I ₄₄ = 3 mA	-	_	0.4	V

SAA7186

12 AC CHARACTERISTICS

 V_{DD1} to V_{DD8} = 4.5 to 5.5 V; T_{amb} = 0 to 60 $^\circ C$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
LLC timing	, (pin 36)	Fig.11	•	4	-1	
t _{LLC}	cycle time		31	-	45	ns
tp	pulse width (duty factor)	t _{LLC H} / t _{LLC}	40	50	60	%
t _r	rise time		_	-	5	ns
t _f	fall time		_	-	6	ns
Input data	and CREF timing	Fig.15				
t _{SU}	setup time		11	-	-	ns
t _{HD}	hold time		3	-	_	ns
VCLK timir	ng (pin 51)	Fig.16	·	•	•	
t _{VCLK}	VRAM port clock cycle time	note 2	50	-	200	ns
t _{pL} , t _{pH}	LOW and HIGH times	note 3	17	-	_	ns
t _r	rise time		_	_	5	ns
t _f	fall time		_	-	6	ns
Output dat	a and reference signal timing	Figures 15 and 16	•	•	•	•
CL	load capacitance	VRO outputs	15	-	40	pF
		other outputs	7.5	_	25	pF
t _{OH}	VRO data hold time	C _L = 10 pF; note 4	0	-	_	ns
t _{OHL}	related to LLC (INCADR, HFL)	C _L = 10 pF; note 5	0		_	ns
t _{OHV}	related to VCLK (HFL)	C _L = 10 pF; note 5	0		-	ns
t _{OD}	VRO data delay time	C _L = 40 pF; note 4	_	-	25	ns
t _{ODL}	related to LLC (INCADR, HFL)	C _L = 25 pF; note 5	-	-	60	ns
t _{ODV}	related to VCLK (HFL)	C _L = 25 pF; note 5	_	-	60	ns
t _D	output disable time to 3-state	C _L = 40 pF; note 6	_	-	40	ns
t _E	output enable time from 3-state	C _L = 40 pF; note 6	_	-	40	ns
t _{HFL VOE}	HFL maximum response time	VRAM port enabled	_	-	810	ns
tHFL VCLK	HFL maximum response time	HFL set at beginning of VCLK burst	-	-	840	ns

Notes

- 1. Levels are measured with load circuit. VRO outputs with 1.2 k Ω in parallel to 25 pF at 3 V (TTL load).
- Maximum t_{VCLK} = 200 ns for test mode only. The applicable maximum cycle time depends on data format, horizontal scaling and input data rate.
- 3. Measured at 1,5 V level; $t_{p L}$ may be unlimited.
- 4. Timings of VRO refer to the rising edge of VLCK.
- 5. The timing of INCADR refers to LLC; the rising edge of HFL always refers to LLC. During a VRAM transfer is the falling edge of HFL generated by VCLK. Both edges of HFL refer to LLC during horizontal increment and vertical reset cycles.
- 6. Asynchronous signals with timing referring to the 1.5 V switching point of VOEN input signal (pin 50).



SAA7186



13 PROCESSING DELAYS

PORTS	DELAY IN LLC	REMARKS
YIN to VRO	58	in transparent mode only
UVIN to VRO	58	in transparent mode only
HREF to VRO	58	in transparent mode only

SAA7186

14 PROGRAMMING EXAMPLE

Slave address byte is B8h at pin IICSA = 0 (or BCh at pin IICSA = +5 V).

This example shows the setting via I²C-bus for the processing of a picture segment at 1:1 horizontal and vertical scale.

Values in brackets [..]:

If no scaling or panning is wanted,

the parameters XD, XS, YD and YS should be set to the maximum value 3FFh.

the parameters XO and YO should be set to the minimum value 000h.

(in this case, HREF and VS from external define the SAA7186 processing window).

SUBADDR. (HEX)	BITS	FUNCTION	VALUE (HEX)	COMMENT
00	RTB, OF(1:0), VPE,	ROM table control and field		
	LW(1:0), FS(1:0),	sequence processing; VRAM port		
		enable; output format select	11	(1)
01	XD(7:0)	LSB's output pixel/line	80 [FF]	384 pixels out
02	XS(7:0)	LSB's input pixel/line	80 [FF]	384 pixels in
03	XO(7:0)	LSB's for horizontal window start	10 [00]	1st pixel after HREF = 1
04	HF(2:0), XO(8),	horizontal filter select and MSB's		
	XS(9, 8), XD(9, 8)	of subaddresses 01, 02, 03	85 [8F]	horizontal filter bypassed
05	YD(7:0)	LSB's output lines/field	90 [FF]	144 lines out
06	YS(7:0)	LSB's input lines/field	90 [FF]	144 lines in
07	YO(7:0)	LSB's vertical window start	03 [00]	1st line after VS = 0; (2)
08	AFS, VP(1:0), YO(8),	adaptive and vertical filter select;		no adaptive select
	YS(9, 8), YD(9, 8)	MSB's of subaddresses 05, 06, 07	00 [FF]	vertical filter bypassed
09	VS(7:0)	LSB's vertical bypass start position	00	not bypassed
0A	VC(7:0)	LSB's vertical bypass lines/field	00	region
0B	VS(8), VC(8), TCC,	MSB's of subaddresses 09, 0A;		_
	POE	UV input data representation and odd/even polarity switch	00	defined; (3) (4)
0C	VL(7:0)	UV keyer: lower limit V (R-Y)	00) keying is switched off
0D	VU(7:0)	UV keyer: upper limit V (R-Y)	FF) by VU < VL
0E	UL(7:0)	UV keyer: lower limit U (B-Y)	00	-
0F	UU(7:0)	UV keyer: upper limit U (B-Y)	00	-
10	MCT, QPP, QPL,	Y or UV output data representation,		
	TTR, EFE	output data transfer mode,		
		pixel/ line qualifier polarity.	00	(5)

Notes

1. RTB = 0 ROM table is active (only for RGB formats)

OF = 00 SAA7186 processes the both fields for interlaced display

VPE = 1 VRAM port is enabled

LW = 00 longword position of first pixel in each output line = 0

FS = 01 16-bit 4:2:2 YUV output format is selected

2. for nominal VS length of 6 × H-period (input SAA7191B respectively SAA7151B with active VNL)

3. TTC = 0 straight binary UV input data expected

- 4. odd/even polarity unchanged can be used to change the field sequence if phase relations between HREF and VS are not according to SAA7191B respectively SAA7151B specification
- 5. MCT = 0 when EFE, FS = 001h: UV output data are straight binary
 - QPP = 0 the pixel qualifier PXQ is "0"-active (if TTR, EFE = 1)
 - QPL = 0 line qualifier LNQ is "0"-active (if TTR, EFE = 1)
 - TTR = 0 VRAM port is set to data burst transfer
 - EFE = 0 32-bit longword formats selected.

SAA7186

15 PACKAGE OUTLINE



16 SOLDERING

16.1 Introduction

There is no soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and surface mounted components are mixed on one printed-circuit board. However, wave soldering is not always suitable for surface mounted ICs, or for printed-circuits with high population densities. In these situations reflow soldering is often used.

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our *"IC Package Databook"* (order code 9398 652 90011).

16.2 Reflow soldering

Reflow soldering techniques are suitable for all QFP packages.

The choice of heating method may be influenced by larger plastic QFP packages (44 leads, or more). If infrared or vapour phase heating is used and the large packages are not absolutely dry (less than 0.1% moisture content by weight), vaporization of the small amount of moisture in them can cause cracking of the plastic body. For more information, refer to the Drypack chapter in our "Quality Reference Handbook" (order code 9397 750 00192).

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement.

Several techniques exist for reflowing; for example, thermal conduction by heated belt. Dwell times vary between 50 and 300 seconds depending on heating method. Typical reflow temperatures range from 215 to 250 °C.

Preheating is necessary to dry the paste and evaporate the binding agent. Preheating duration: 45 minutes at 45 °C.

16.3 Wave soldering

Wave soldering is **not** recommended for QFP packages. This is because of the likelihood of solder bridging due to closely-spaced leads and the possibility of incomplete solder penetration in multi-lead devices.

If wave soldering cannot be avoided, the following conditions must be observed:

- A double-wave (a turbulent wave with high upward pressure followed by a smooth laminar wave) soldering technique should be used.
- The footprint must be at an angle of 45° to the board direction and must incorporate solder thieves downstream and at the side corners.

Even with these conditions, do not consider wave soldering the following packages: QFP52 (SOT379-1), QFP100 (SOT317-1), QFP100 (SOT317-2), QFP100 (SOT382-1) or QFP160 (SOT322-1).

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Maximum permissible solder temperature is 260 °C, and maximum duration of package immersion in solder is 10 seconds, if cooled to less than 150 °C within 6 seconds. Typical dwell time is 4 seconds at 250 °C.

A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

16.4 Repairing soldered joints

Fix the component by first soldering two diagonallyopposite end leads. Use only a low voltage soldering iron (less than 24 V) applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to 300 °C. When using a dedicated tool, all other leads can be soldered in one operation within 2 to 5 seconds between 270 and 320 °C.

SAA7186

17 DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
more of the limiting values r of the device at these or at a	accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or nay cause permanent damage to the device. These are stress ratings only and operation any other conditions above those given in the Characteristics sections of the specification imiting values for extended periods may affect device reliability.
Application information	

Where application information is given, it is advisory and does not form part of the specification.

18 LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

19 PURCHASE OF PHILIPS I²C COMPONENTS



Purchase of Philips I²C components conveys a license under the Philips' I²C patent to use the components in the I²C system provided the system conforms to the I²C specification defined by Philips. This specification can be ordered using the code 9398 393 40011.

SAA7186

NOTES

SAA7186

NOTES

SAA7186

NOTES

Philips Semiconductors – a worldwide company

Argentina: see South America Australia: 34 Waterloo Road, NORTH RYDE, NSW 2113, Tel. +61 2 9805 4455, Fax. +61 2 9805 4466 Austria: Computerstr. 6, A-1101 WIEN, P.O. Box 213, Tel. +43 1 60 101. Fax. +43 1 60 101 1210 Belarus: Hotel Minsk Business Center, Bld. 3, r. 1211, Volodarski Str. 6, 220050 MINSK, Tel. +375 172 200 733, Fax. +375 172 200 773 Belgium: see The Netherlands Brazil: see South America Bulgaria: Philips Bulgaria Ltd., Energoproject, 15th floor, 51 James Bourchier Blvd., 1407 SOFIA, Tel. +359 2 689 211, Fax. +359 2 689 102 Canada: PHILIPS SEMICONDUCTORS/COMPONENTS, Tel. +1 800 234 7381 China/Hong Kong: 501 Hong Kong Industrial Technology Centre, 72 Tat Chee Avenue, Kowloon Tong, HONG KONG, Tel. +852 2319 7888, Fax. +852 2319 7700 Colombia: see South America Czech Republic: see Austria Denmark: Prags Boulevard 80, PB 1919, DK-2300 COPENHAGEN S, Tel. +45 32 88 2636, Fax. +45 31 57 0044 Finland: Sinikalliontie 3, FIN-02630 ESPOO, Tel. +358 9 615800, Fax. +358 9 61580920 France: 4 Rue du Port-aux-Vins. BP317. 92156 SURESNES Cedex. Tel. +33 1 40 99 6161, Fax. +33 1 40 99 6427 Germany: Hammerbrookstraße 69, D-20097 HAMBURG, Tel. +49 40 23 53 60, Fax. +49 40 23 536 300 Greece: No. 15, 25th March Street, GR 17778 TAVROS/ATHENS, Tel. +30 1 4894 339/239, Fax. +30 1 4814 240 Hungary: see Austria India: Philips INDIA Ltd, Shivsagar Estate, A Block, Dr. Annie Besant Rd. Worli, MUMBAI 400 018, Tel. +91 22 4938 541, Fax. +91 22 4938 722 Indonesia: see Singapore Ireland: Newstead, Clonskeagh, DUBLIN 14, Tel. +353 1 7640 000, Fax. +353 1 7640 200 Israel: RAPAC Electronics, 7 Kehilat Saloniki St, PO Box 18053, TEL AVIV 61180, Tel. +972 3 645 0444, Fax. +972 3 649 1007 Italy: PHILIPS SEMICONDUCTORS, Piazza IV Novembre 3, 20124 MILANO, Tel. +39 2 6752 2531, Fax. +39 2 6752 2557 Japan: Philips Bldg 13-37, Kohnan 2-chome, Minato-ku, TOKYO 108, Tel. +81 3 3740 5130, Fax. +81 3 3740 5077 Korea: Philips House, 260-199 Itaewon-dong, Yongsan-ku, SEOUL, Tel. +82 2 709 1412, Fax. +82 2 709 1415 Malaysia: No. 76 Jalan Universiti, 46200 PETALING JAYA, SELANGOR, Tel. +60 3 750 5214, Fax. +60 3 757 4880 Vietnam: see Singapore Mexico: 5900 Gateway East, Suite 200, EL PASO, TEXAS 79905, Tel. +9-5 800 234 7381 Middle East: see Italy

Netherlands: Postbus 90050, 5600 PB EINDHOVEN, Bldg. VB, Tel. +31 40 27 82785, Fax. +31 40 27 88399 New Zealand: 2 Wagener Place, C.P.O. Box 1041, AUCKLAND, Tel. +64 9 849 4160, Fax. +64 9 849 7811 Norway: Box 1, Manglerud 0612, OSLO, Tel. +47 22 74 8000, Fax. +47 22 74 8341 Philippines: Philips Semiconductors Philippines Inc., 106 Valero St. Salcedo Village, P.O. Box 2108 MCC, MAKATI, Metro MANILA, Tel. +63 2 816 6380, Fax. +63 2 817 3474 Poland: UI. Lukiska 10, PL 04-123 WARSZAWA, Tel. +48 22 612 2831, Fax. +48 22 612 2327 Portugal: see Spain Romania: see Italy Russia: Philips Russia, UI. Usatcheva 35A, 119048 MOSCOW, Tel. +7 095 755 6918, Fax. +7 095 755 6919 Singapore: Lorong 1, Toa Payoh, SINGAPORE 1231, Tel. +65 350 2538, Fax. +65 251 6500 Slovakia: see Austria Slovenia: see Italy South Africa: S.A. PHILIPS Pty Ltd., 195-215 Main Road Martindale, 2092 JOHANNESBURG, P.O. Box 7430 Johannesburg 2000, Tel. +27 11 470 5911, Fax. +27 11 470 5494 South America: Rua do Rocio 220, 5th floor, Suite 51, 04552-903 São Paulo, SÃO PAULO - SP, Brazil, Tel. +55 11 821 2333, Fax. +55 11 829 1849 Spain: Balmes 22 08007 BARCELONA Tel. +34 3 301 6312. Fax. +34 3 301 4107 Sweden: Kottbygatan 7, Akalla, S-16485 STOCKHOLM, Tel. +46 8 632 2000, Fax. +46 8 632 2745 Switzerland: Allmendstrasse 140, CH-8027 ZÜRICH, Tel. +41 1 488 2686, Fax. +41 1 481 7730 Taiwan: Philips Semiconductors, 6F, No. 96, Chien Kuo N. Rd., Sec. 1, TAIPEI, Taiwan Tel. +886 2 2134 2865, Fax. +886 2 2134 2874 Thailand: PHILIPS ELECTRONICS (THAILAND) Ltd. 209/2 Sanpavuth-Bangna Road Prakanong, BANGKOK 10260, Tel. +66 2 745 4090, Fax. +66 2 398 0793 Turkey: Talatpasa Cad. No. 5, 80640 GÜLTEPE/ISTANBUL, Tel. +90 212 279 2770, Fax. +90 212 282 6707 Ukraine: PHILIPS UKRAINE, 4 Patrice Lumumba str., Building B, Floor 7, 252042 KIEV, Tel. +380 44 264 2776, Fax. +380 44 268 0461 United Kingdom: Philips Semiconductors Ltd., 276 Bath Road, Haves. MIDDLESEX UB3 5BX, Tel. +44 181 730 5000, Fax. +44 181 754 8421 United States: 811 East Arques Avenue, SUNNYVALE, CA 94088-3409, Tel. +1 800 234 7381 Uruguay: see South America

Yugoslavia: PHILIPS, Trg N. Pasica 5/v, 11000 BEOGRAD, Tel. +381 11 625 344, Fax.+381 11 635 777

For all other countries apply to: Philips Semiconductors, Marketing & Sales Communications, Building BE-p, P.O. Box 218, 5600 MD EINDHOVEN, The Netherlands, Fax. +31 40 27 24825

© Philips Electronics N.V. 1997

SCA54

All rights are reserved. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner.

The information presented in this document does not form part of any quotation or contract, is believed to be accurate and reliable and may be changed without notice. No liability will be accepted by the publisher for any consequence of its use. Publication thereof does not convey nor imply any license under patent- or other industrial or intellectual property rights.

Printed in The Netherlands

657027/00/01/pp44

Date of release: May 1993

Document order number: 9397 750 02436

Let's make things better.

Internet: http://www.semiconductors.philips.com



